

**4A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER
POWERDI**
Product Summary (@T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V)	I _{R(MAX)} (μA)
200	4	0.84	1

Features and Benefits

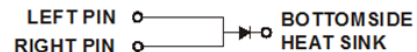
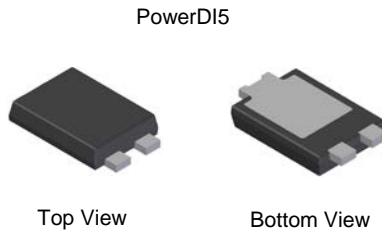
- Lower Forward Voltage Drop than Ultrafast Rectifiers
- Very Low Leakage Current
- Soft Recovery Characteristics: Softness Factor (t_B/t_A) ≥ 1 (See Figure 8)
- Highly Stable Oxide Passivated Junction
- High Forward Surge Current Capability
- **Lead-Free Finish & RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

Applications

- SMPS
- DC-DC Converter
- Freewheeling Diodes
- AC-DC

Mechanical Data

- Case: PowerDI5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 [Ⓔ]
- Polarity: See Diagram
- Weight: 0.095 grams (Approximate)

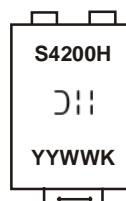


Note: Pins Left & Right must be electrically connected at the printed circuit board.

Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging
PDS4200HQ-13	Automotive	PowerDI5	5,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
 5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information


- S4200H = Product Type Marking Code
- ⌋⌋ = Manufacturers' Code Marking
- YYWW = Date Code Marking
- YY = Last Two Digits of Year (ex: 16 for 2016)
- WW = Week Code (01 to 53)
- K = Factory Designator

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	200	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_R		
RMS Reverse Voltage	$V_{R(RMS)}$	141	V
Average Rectified Output Current	I_O	4	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-wave Superimposed on Rated Load	I_{FSM}	100	A

Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{\theta JS}$	—	3.0	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{\theta JA}$	80	—	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 7)	$R_{\theta JA}$	65	—	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 8)	$R_{\theta JA}$	45	—	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +175		$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 9)	$V_{(BR)R}$	200	—	—	V	$I_R = 5\mu\text{A}$
Forward Voltage	V_F	—	0.76	0.82	V	$I_F = 3\text{A}, T_S = +25^\circ\text{C}$
		—	—	0.59		$I_F = 3\text{A}, T_S = +150^\circ\text{C}$
		—	0.785	0.84		$I_F = 4\text{A}, T_S = +25^\circ\text{C}$
		—	0.61	0.64		$I_F = 4\text{A}, T_S = +150^\circ\text{C}$
		—	0.84	0.89		$I_F = 8\text{A}, T_S = +25^\circ\text{C}$
		—	0.68	0.75		$I_F = 8\text{A}, T_S = +150^\circ\text{C}$
Reverse Leakage Current (Note 9)	I_R	—	0.2	1	μA	$T_S = +25^\circ\text{C}, V_R = 200\text{V}$
		—	0.8	4	mA	$T_S = +150^\circ\text{C}, V_R = 200\text{V}$
Reverse Recovery Time	t_{RR}	—	—	25	ns	$I_F = 0.5\text{A}, I_R = 1.0\text{A}$ $I_{RR} = 0.25\text{A}$ (See Figure 8)

- Notes:
- FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
 - Polymide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
 - Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
 - Short duration test pulse used to minimize self-heating effect.

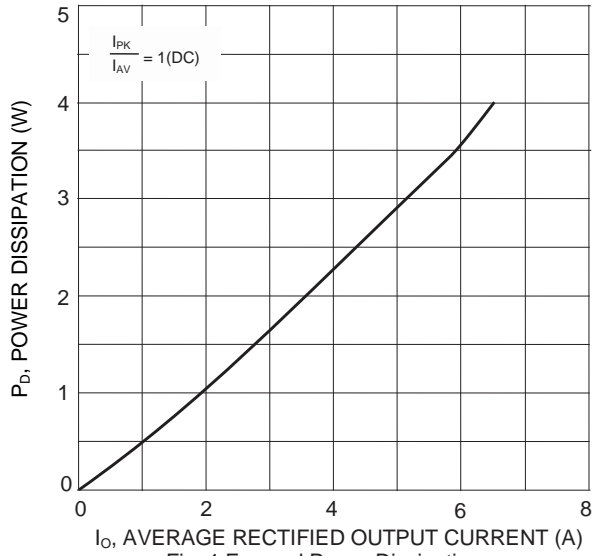


Fig. 1 Forward Power Dissipation

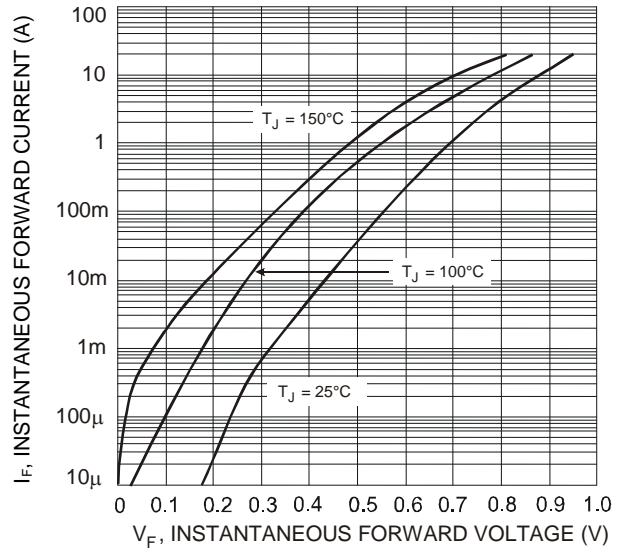


Fig. 2 Typical Forward Characteristics

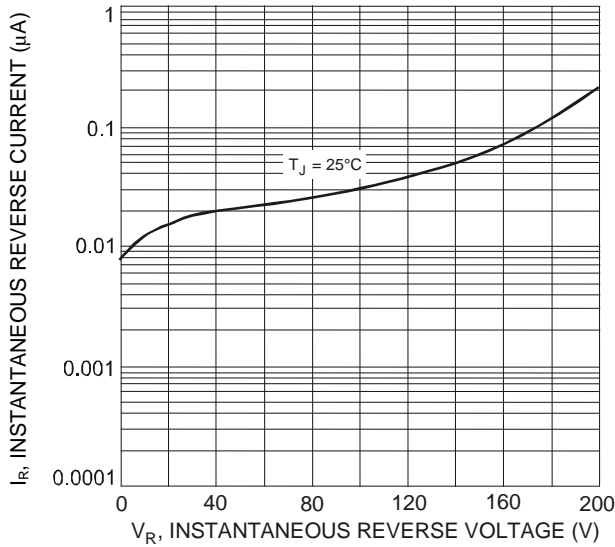


Fig. 3 Typical Reverse Characteristics

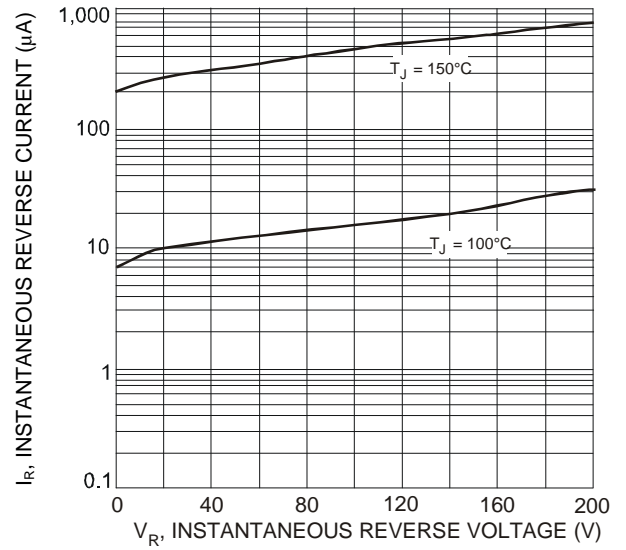


Fig. 4 Typical Reverse Characteristics

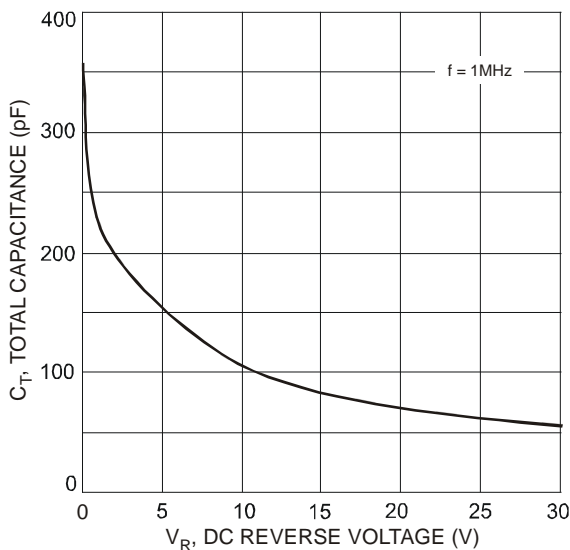


Fig. 5 Total Capacitance vs. Reverse Voltage

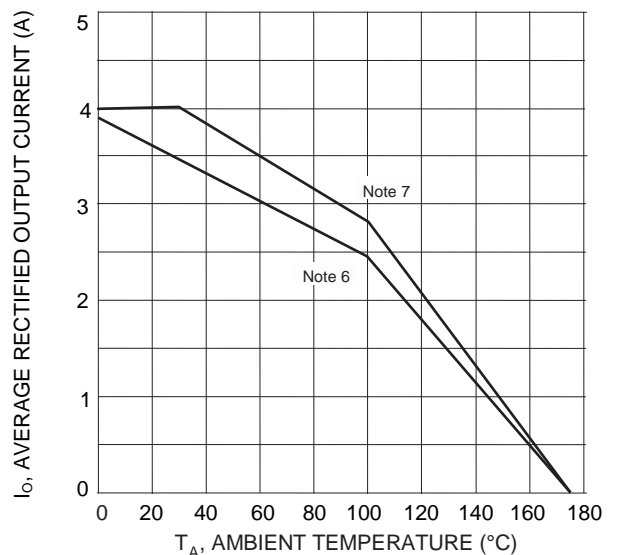


Fig. 6 Forward Current Derating Curve

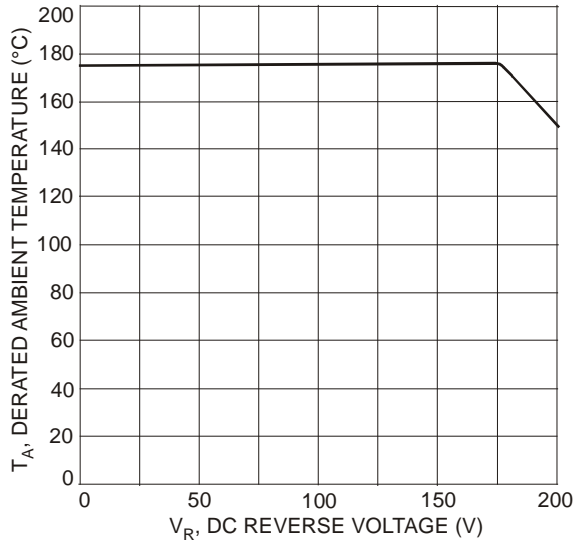
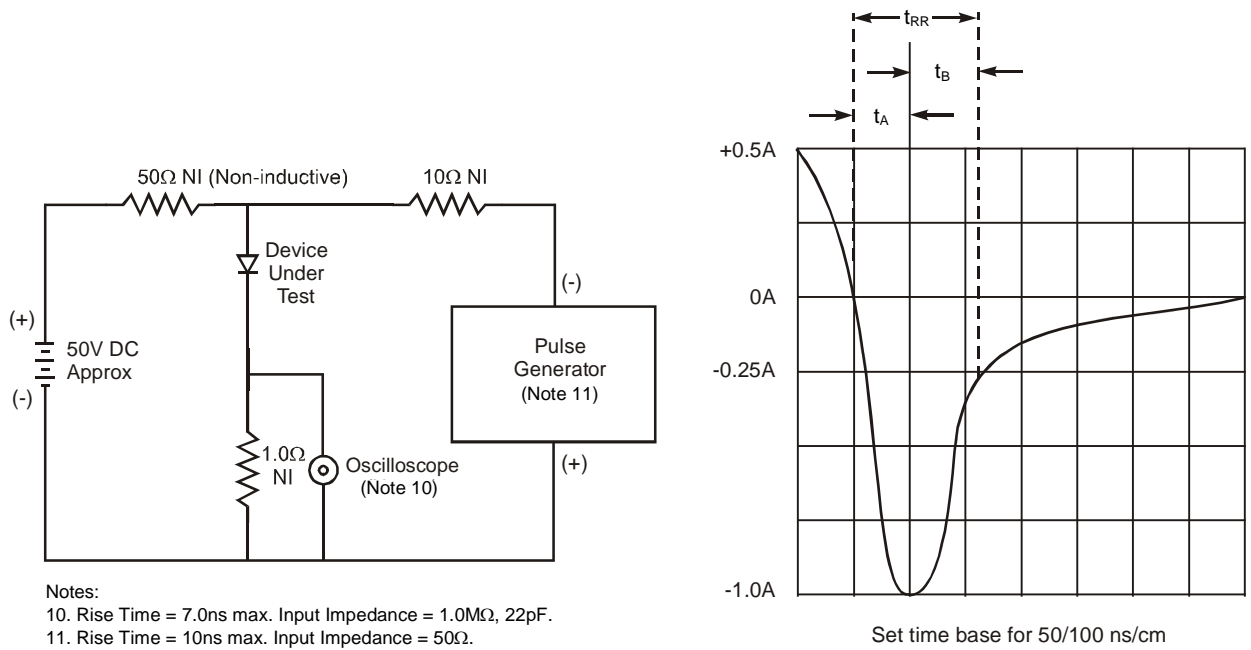


Fig. 7 Operating Temperature Derating



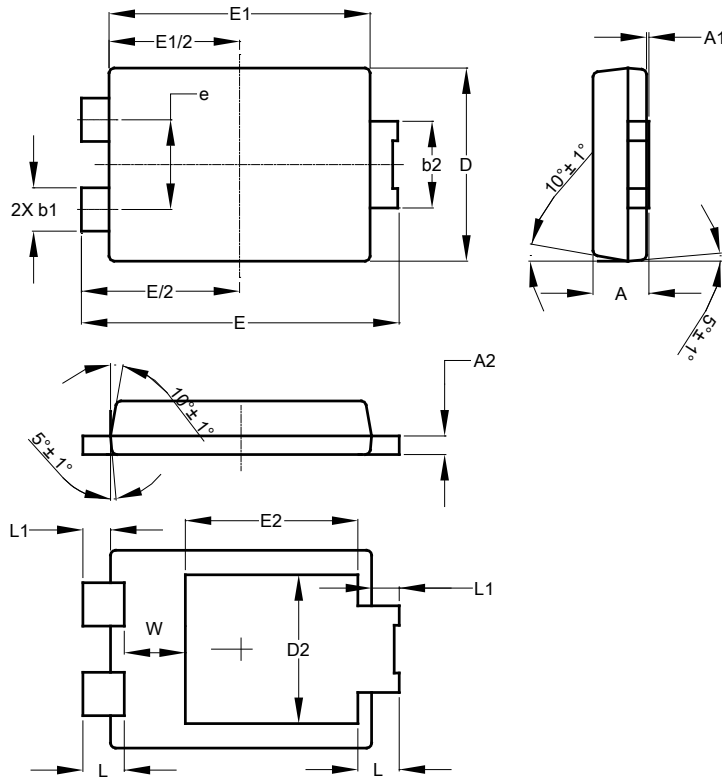
Notes:
 10. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.
 11. Rise Time = 10ns max. Input Impedance = 50Ω.

Fig. 8 Reverse Recovery Time Characteristic and Test Circuit

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI5

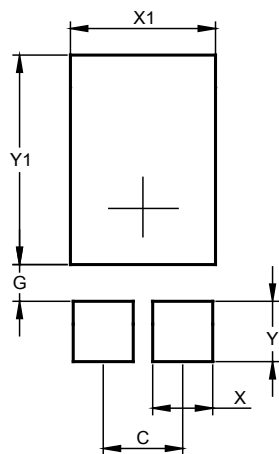


PowerDI5			
Dim	Min	Max	Typ
A	1.05	1.15	1.10
A1	0.00	0.05	--
A2	0.33	0.43	0.381
b1	0.80	0.99	0.89
b2	1.70	1.88	1.78
D	3.90	4.05	3.966
D2	--	--	3.054
E	6.40	6.60	6.504
e	--	--	1.84
E1	5.30	5.45	5.37
E2	--	--	3.549
L	0.75	0.95	0.85
L1	0.50	0.65	0.57
W	1.10	1.41	1.255
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI5



Dimensions	Value (in mm)
C	1.840
G	0.852
X	1.390
X1	3.360
Y	1.400
Y1	4.860

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